SPEC	IFICA	TIONS	S FOR	APPROVA		H.ELE RoHS Compliant	
Customer F	Part No.:			HELE. Part No:	X2B024	<u>000FK1H</u>	-V
Application	n For:			Products:	CR	YSTAL	
Accepted Model: Type & Freq.:						Hz	
		EOS-G6009					
Approved By: 加高電子股份有限公司 加高電子股份有限公司 加高電子股份有限公司 加高電子股份有限公司 加高電子股份有限公司 Ammony Electronics corp. HARMONY ELECTRONICS (THAILAND) CO., LTD. HARMONY ELECTRONICS (SHENZHEN) CORP., LTD. EMPLOPICE: IMMON MARCHER (SHENZHER)						格聚源工業區	
台北市內湖區堤頂大 2F., NO.409, SEC.2, 1 NEIHU DISTRICT, T TAIWAN TEL:886-2-26588883 FAX:886-2-26588683	TIDING BLVD., AIPEI CITY 114,	高雄市大寮區大發工 No.39, HWA DONG I DIST., DAFA INDUST KAOHSIUNG CITY TEL: (07)787-1555-6 FAX: (07)787-1557	RD., DALLIAO FRIAL PARK., 831, TAIWAN	T.BEOKPRAI, A. BANPONG, RAJCHABUREE PROVINCE 701 THAILAND TEL: (032)221994-6, 200740-1 FAX: (032)200742	10, FU YON CHINA TEL: 07	ANG RD., TANGW NG TOWN SHENZ 55-27309272 / 27309262 755-27309755	
Tittle HSX221 QU	ARTZ CRYS	TAL SPECIF	ICATION	Country of origin	TAIWAN THAILAN CHINA		ORY
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HSX221SA SPECIFICATION

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HARMONY FIECTRONICS CORP.							

1. QUARTZ CRYSTAL UNIT SPECIFICATION

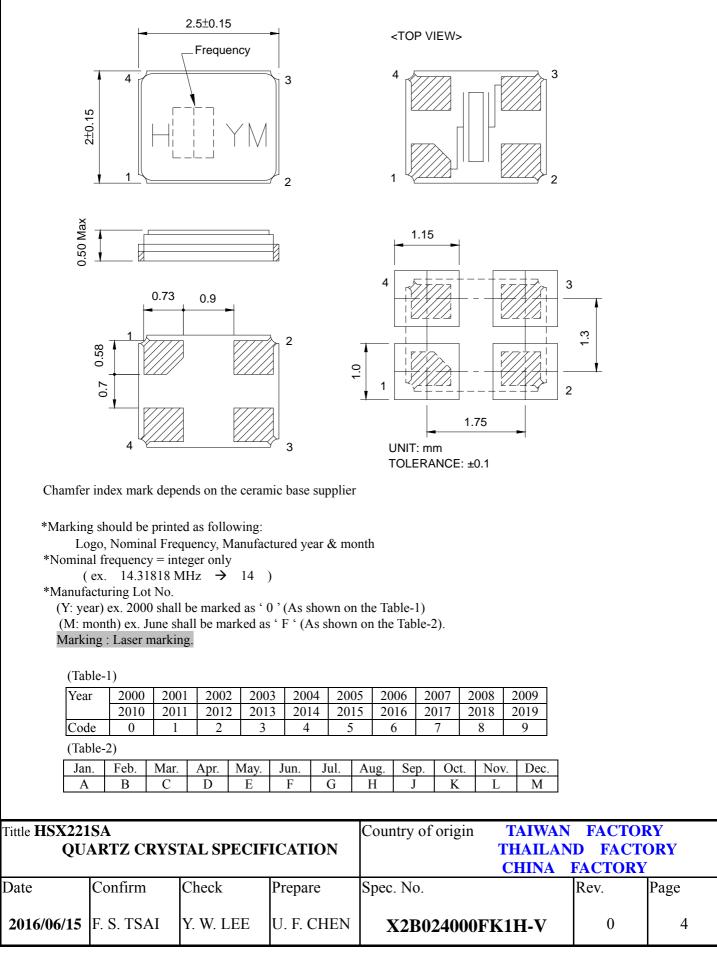
1. Fre	quency:		24.0	0000	0MHz				
2. Ho	lder type :		HSZ	X221	SA				
3. Fre	quency tolera	nce:	+/-3	0 pp	m at 25de	g.C +/-3d	eg.C		
4. Eq.	4. Equivalent resistance:			ohm	s Max. / S	ERIES			
5. Sto	5. Storage temperature range:			deg.(C To +125	deg.C			
6. Op	6. Operable temperature range:			deg.(C To +75 d	deg.C			
7. Ten	7. Temperature drift:			80ppr	n	-20 deg.	C To +75	deg.C	
8. Loa	ading capacita	ance (CL) :	20.0) pF					
9. Dri	ve level:		10 լ	ιW	(100uW	Max.)			
10. Sł	10. Shunt Capacitance:			pF	Max.				
11. In	1				n 500M o	hms at D	C 100V		
12. M	ode of oscilla	tion:	Fun	dame	ental				
13. Ci	ircuit:		Mea	asure	d in HP/E	5100A,S&	&A 250B		
14. Sł	nocking :		Dro	pping	g from 120	0 cm heig	ht 3 times	on Concr	ete floor
Va	ariation :		Free	quenc	y less that	n +/-5 ppi	m		
			Res	istanc	ce less tha	n +/- 15	% or 20hr	ns max.	
15. Aş	ging:		Les	s thar	n +/- 3 ppr	n/Year			
16. He	older		HSZ	X221	SA Seam	type			
17. Di	imensions and	d marking	Ref	er to j	page.4				
18. Er	mboss carrier	tape & reel	Ref	er to j	page.6 and	d page.7			
19. M	loisture Sensit	tivity Level	Lev	el 1					
20. No	ote:								
Tittle HSX221				Cou	ntry of ori	•	TAIWAN	FACTO	
QU	ARTZ CRYS	STAL SPECI	FICATION				HAILAN HINA	D FACT FACTOR	
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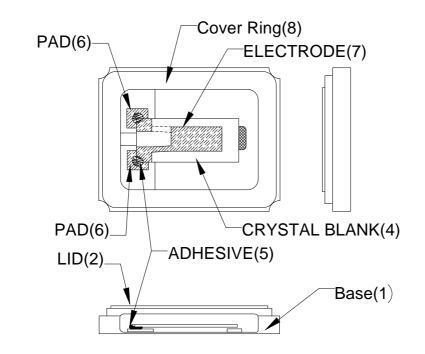
2. HSX221SA MARKING & DIMENSIONS



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3. INSIDE STRUCTURE



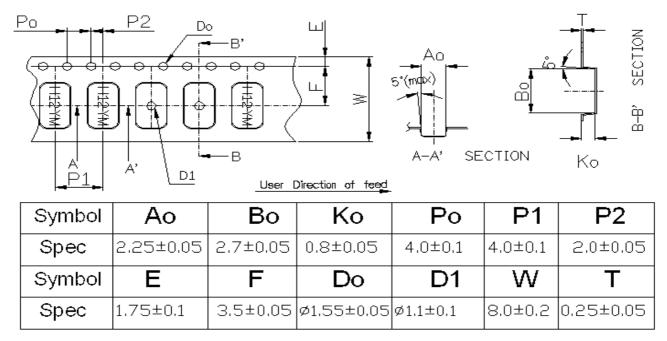
%Reference drawing

 (1) Base: Alumina Ceramic (Al₂O₃) (6) Metallized Pad: W Ni Plating Au Plating (2) Lid : Fe- Ni -Co 	The use prohibition chemistry substance of Table 1 of DHE-0204-1 (HE-QA-24) is not included in this item.
(3) Crystal Enclosure Seal: Seal Seam (4) Crystal Blank Rectangular At-Cut Quartz Crystal Blank (5) Adhesive Silver Conductive Silicon Resin	
(7) Electrode(8) Cover Ring : Fe-Ni-Co Alloy	

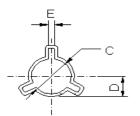
QUARTZ CRYSTAL SPECIFICATION			THAILA	N FACTO ND FACT FACTORY	ORY	
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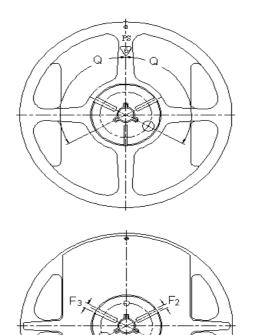
4. HSX221SA EMBOSS CARRIER TAPE & REEL

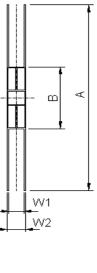
a.) Dimensions of Carrier Tape



b.) Dimensions of Reel







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2016/06/15 F S TSAL Y W LEE U F CHEN X2B024000FK1H-V 0 6	Date	Confirm	Check	Prepare	Spec. No.		Rev.	Page
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(Table-2	2)			(UNIT: mm)
	ITEM			DIMENSIONS • ANGLE
Diameter			А	ψ180+0/-3
FLANCE	Inner	Width	W1	9.3+/-0.3
	Outer	Width	W2	11.3+/-1.0
	Out Line	diameter	В	ψ60.5+/-0.5
HUB			F1	3.0+0.5/-0
	Center	Width	F2	4.0+0.5/-0
	Core slit		F3	5.0+0.5/-0
		Position	Q	120deg
	Spindle	diameter	С	ψ13.2+/-0.5
	Key Ditch	Width	Е	3.0+/-0.2

c.) Storage condition

Temperature: +40deg.C Max. Relative Humidity: 80% Max.

- d.) Standard packing quantity 3,000PCS / REEL
- e.) Material of the tape

Таре	Material
Carrier tape	PS Conductive
Top tape	Polyester

f.) Label contents

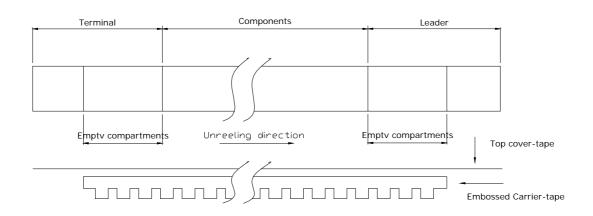
● 影影影響影響影響				
TYPE:				
SPEC No.:				
Parts No.:				
Lot No.:				
FREQ.:	MHz			
Q'TY:	PCS			
HARMONY ELECTRONICS	CORP. (H.ELE.) HSF			

Sticks label for every reel.

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g.) Taping dimension

Leader	Cover-tape	The length of cover-tape in the leader is more than 400 mm including empty embossed area.
Leader	Carrier-tape	After all products were packaged, must remain more than twenty pieces or 400 mm empty area, which should be sealed by cover-tape.
Cover-tape		The tip of cover-tape shall be fixed temporary by paper tape and roll around the core of reel one round.
Terminal	Carrier-tape	The empty embossed area which are sealed by top cover-tape must remain more the 40 mm.



h.) Joint of tape

The carrier-tape and top cover-tape should not be jointed.

i.) Release strength of cover tape

It has to between 0.1N to 0.7N under following condition.

Pulling direction 165° to 180°

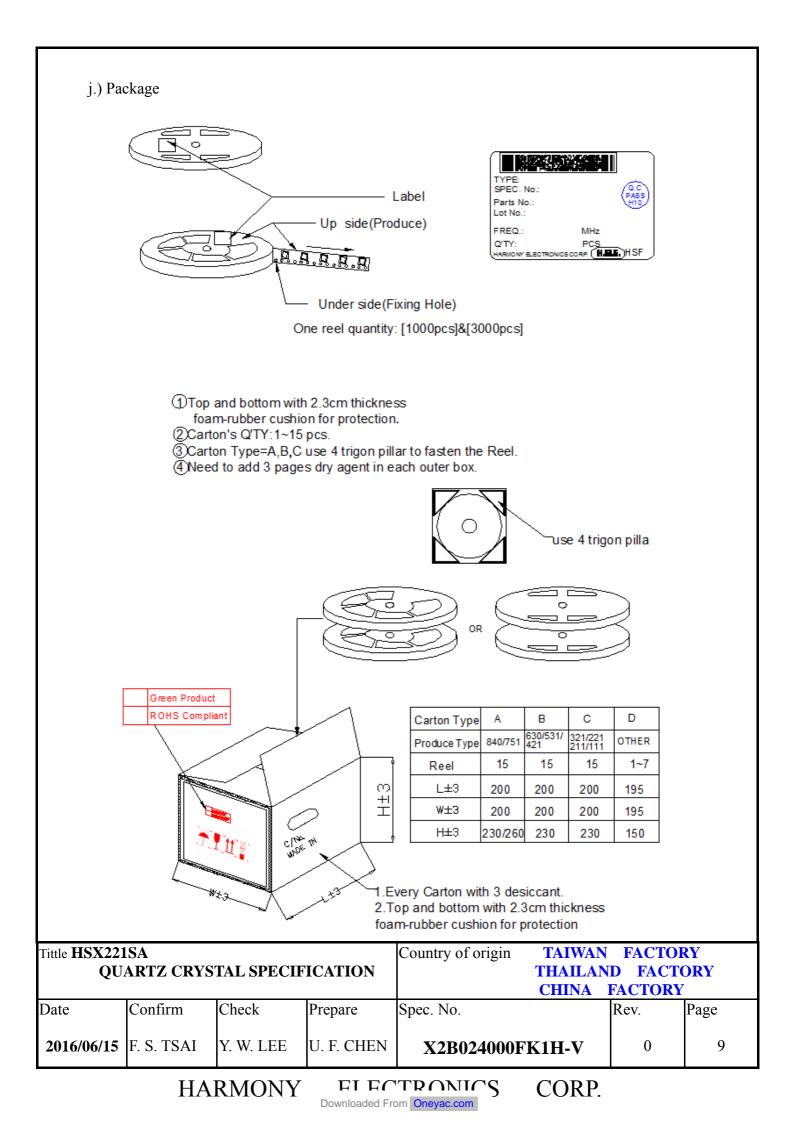
Speed 300mm/min.

Otherwise unless specified.

165°~ 180°
Pulling direction

Other standards shall be based on JIS C 0806-1990.

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				CORP.		



5. Mechanical Performance

Item		Test Methods			Specifications Code		
1	Natural Drop	Dropping fro Refer to: JIS	-	3 times on Concrete floor	A		
2	Vibration	Frequency 10 3 axes, Durat	Frequency 10-55Hz, Sine Wave full amplitude of 0.8mm to X, Y and Z 3 axes, Duration of 2 hours to each axis. Refer to: MIL-HDBK-781A 6.5.2/ JIS C 60068-2-6				
3 5	Sealing Tightness			Max. Measured by Helium leak			
4 5	Solder ability	After applyin 245deg.C+/-5	After applying ROSIN Flux, dipping in solder bath at 245deg.C+/-5deg.C for 3+/-0.5 sec. Refer to: JIS C 60068-2-20				
5 5	Substrate Bending	Mount a sam Apply Pressu center of boa bent to 3 mm for 5 ± 1 sec Pressure spee Refer to: EIA	re to the rd until it is and hold ed :0.5 mm / sec	Pressure rod 20 R230 Board 45 ± 2 45 ± 2	Α		
6 /	Adhesion	Mount a sam the circuit bo Apply pressu vertically to t of specimen a to the circuit with the press Pressure : 5N Refer to: EIA	ard. re he side attached board sure jig. for 10±1 sec	Scratch tool R0.5 Chip Chip Chip	Α		
7]	Body strength	Apply pressu center of bod R0.5 pressure pressure :10N Refer to: EIA	y with the e jig. N for 10±1sec	Pressure rod Pressure ↓ R0.5 Chip L L W L L	Α		
le HSX2	21SA UARTZ CRYS	TAL SPECI	FICATION	THAILANI	FACTORY D FACTORY FACTORY		
V		1	-	Seea Ma	Rev. Page		
te	Confirm	Check	Prepare	Spec. No.	rage		

6. Environment Performance

Item		Test Methods	Specifications Code
1	Humidity	Temperature $60^{\circ}C$ +/-2°C, RH 90~95%, Duration of 240 hours. Back to room temperature first, then in 1~2 hours, the component shall be checked. Refer to: JIS C 60068-2-3	Α
2	Storage in Low Temperature	-40deg.C +/-2deg.C, Duration of 240 hours. Back to the room temperature first, then in 1~2 hours, the component shall be checked. Refer to: JIS C 60068-2-1	Α
3	Storage in High Temperature	+85deg.C +/-2deg.C, Duration of 240 hours. Back to the room temperature first, then in 1~2 hours, the component shall be checked. Refer to: JIS C 60068-2-2	Α
4	Temperature cycles	-40deg.C +/-2deg.C (30min) ↔ +85deg.C +/-2deg.C (30min) 25 cycles. Back to the room temperature first, then in 1~2 hours, the component shall be checked. Refer to: JIS C 0025	Α

Specifications code	Specifications
Α	Frequency variation shall be within +/-5ppm and equivalent resistance shall be within
	+/-15% or 2Ω
В	More than 90% of lead shall be covered by new solder.

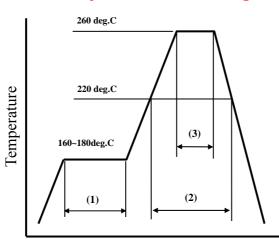
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	HA	RMONY		TRONICS CORI).	

7. Supplement

7.1.Soldering

7.2.Please stay with our proposed reflow condition and do then soldering 2 times max.

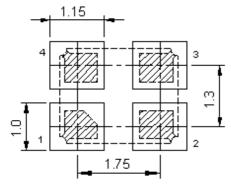
Available for Lead Free Soldering



Time

(1)	Preheat	160~180	deg.C	120sec.
(2)	Primary heat	220	deg.C	60sec.
(3)	Peak	260	deg.C	10sec. Max.

7.3.Land pattern layout(Example)



7.4.Solder iron (Example) Bit temp.: 350°C max., Time:3sec max., Each terminal solder a 1 time max.

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7.5.Mounting

This component is designed for automatic insertion.

However, you are requested to do the trial with your insertion machine in order to be Sure of proper operation and no damage of component.

Please pay attention to board warp which may damage the component and cause Soldering process.

Avoid mounting and processing by Ultrasonic welding because this method has a Possibility of an excessive vibration spreading inside the crystal products and Becoming the cause of characteristic deterioration and not oscillating.

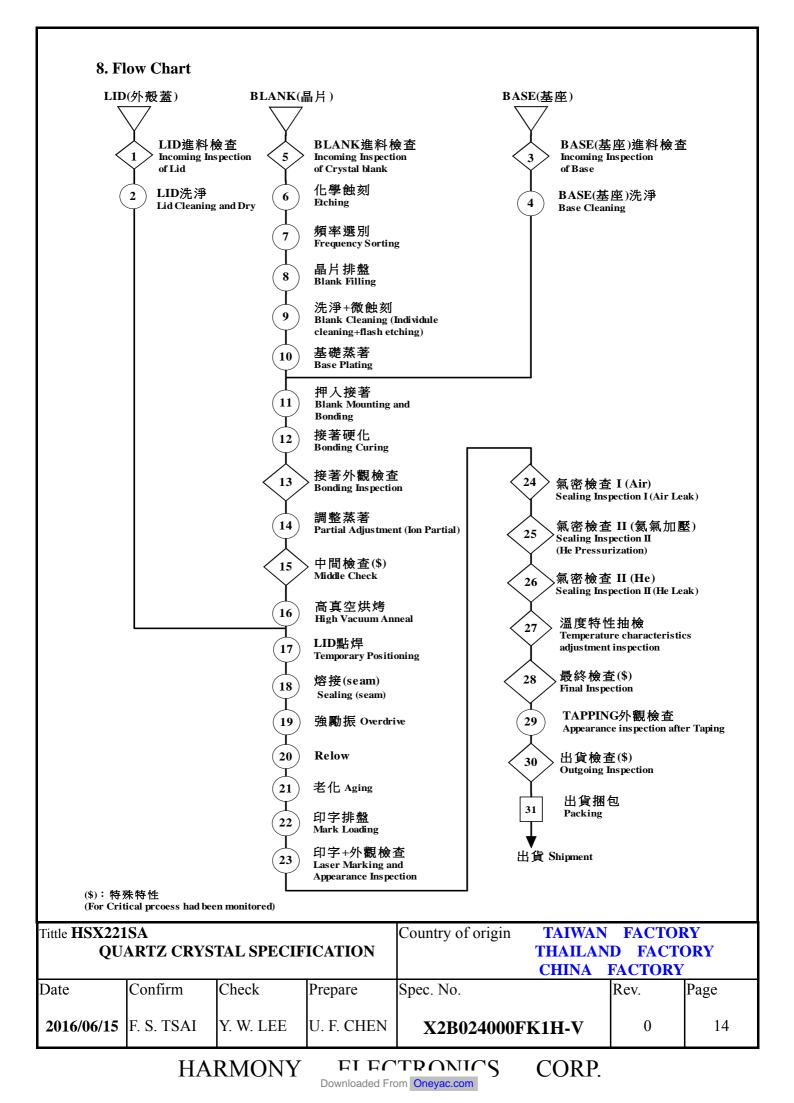
7.6.Cleaning

Cleaning liquid which corrodes Nickel shall not be used It may cause the problem on the surface, color, marking etc. Ultra-sonic cleaning is possible, however, you are requested to check on your board. Because we only checked as single unit.

7.7.Storage

Please keep away from high temperature and high humidity, which may cause put solderbility. No direct Sunlight, No dew as well.

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Environmental Workload Chemical Substance Components List					
TYPE PERCENTAGE	HSX	221S			
Chemical Substance Components	9.6(mg)	ppm			
Si	0.316800	30.412800			
Au	0.048000	4.608000			
Co & Co Compound	0.784320	75.294720			
Mo & Mo Compound	0.017280	1.658880			
Ag	1.875840	180.080640			
Cu	0.075840	7.280640			
Cr & Cr Compound	0.024000	2.304000			
Al	2.083200	199.987200			
Mn & Mn Compound	0.014400	1.382400			
W & W Compound	0.042240	4.055040			
Ni & Ni Compound	2.090880	200.724480			
Fe	2.220480	213.166080			

9. Environmental Workload Chemical Substance Components List

Tittle HSX221SA QUARTZ CRYSTAL SPECIFICATION				HAILAN	FACTOR FACTORY	ORY	
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÷ .	2016/06/15	New					
HSX22 QU		STAL SPEC	IFICATION	Country of origin	TAIWAN THAILAN	D FACTO	ORY
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	F. S. TSAI	Y. W. LEE	U. F. CHEN	X2B024000F	K1H-V	0	16

单击下面可查看定价,库存,交付和生命周期等信息

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